

PRESS RELEASE

New CEO at GS Swiss PCB AG

St. Gallen/Küssnacht a. R., 17 September 2013 – Effective immediately, Mr Daniel Puschmann (47), Graduate Engineer of Microtechnology, will assume the position of CEO of GS Swiss PCB AG. Since 2004, Daniel Puschmann has headed the marketing and business development segment of the Swiss specialist for electronic miniaturization in medical technology. He was previously active as development engineer at the Japanese company MEDOMAN (a manufacturer of robots and manipulators) and as international key account manager for MIXPAC (a manufacturer of mixing and dispensing systems) in the medical technology field. He was thus able to gain extensive experience in the development and manufacture of miniaturized electronic components and build up ample sector expertise in the medical technology industry.

“GS Swiss PCB maintains a leading role as a successful manufacturer of highly miniaturized and highly reliable PCBs, with clients in Europe, the US and Asia. I want to drive this success forward, particularly in the US and in the field of implants and miniaturization, in order to further entrench our market leadership. We want to expand our competitiveness and exploit our head start in various fields, but especially in prototype design”, says Daniel Puschmann in describing his future mission.

About GS SWISS PCB AG

GS Swiss PCB AG is a Swiss manufacturer of high-performance flex-, rigid-flex and HDI substrates and employs more than 150 staff.

About exceet Group

exceet is an international technology corporation specializing in the manufacture of intelligent, complex and secure electronics.

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